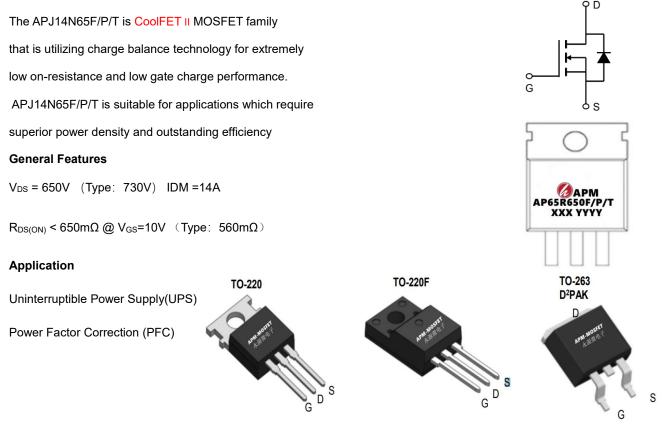


### 650V N-Channel Enhancement Mode MOSFET

#### Description



#### Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
APJ14N65F	TO-220F-3L	AP65R650F XXX YYYY	1000
APJ14N65P	TO-220-3L	AP65R650P XXX YYYY	1000
APJ14N65T	TO-263-3L	AP65R650T XXX YYYY	1000

#### Absolute Maximum Ratings (Tc=25°C unless otherwise noted)

Symbol	Parameter	Value	Unit
VDSS	Drain-Source Voltage (V <sub>GS</sub> = 0V)	650	V
ID	Continuous Drain Current	8	А
IDM	Pulsed Drain Current (note1)	14	Α
VGS	Gate-Source Voltage	±30	V
Eas	Single Pulse Avalanche Energy (note2)	125	mJ
PD	Power Dissipation ( $T_c = 25^{\circ}C$ ) 25.5		W
TJ, Tstg	TJ, Tstg Operating Junction and Storage Temperature Range -55~+150		°C
RthJC	Thermal Resistance, Junction-to-Case	4.9	°C/W
RthJA	nJA Thermal Resistance, Junction-to-Ambient 49		°C/W

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#### Electrical Characteristics (T<sub>J</sub>=25°C, unless otherwise noted)

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
BVDSS	Drain to source breakdown voltage	V <sub>GS</sub> =0V, I <sub>D</sub> =250uA	650	700		V
$\Delta BV_{DSS}$ / $\Delta TJ$	Breakdown voltage temperature coefficient	I <sub>D</sub> =250uA, referenced to 25°C		0.7		V/ºC
17.00		V <sub>DS</sub> =650V, V <sub>GS</sub> =0V			1	uA
IDSS	Drain to source leakage current	V <sub>DS</sub> =520V, T <sub>C</sub> =125°C	-		50	uA
IGSS	Gate to source leakage current, forward V <sub>GS</sub> =30V, V <sub>DS</sub> =0V				100	nA
1633	Gate to source leakage current, reverse	V <sub>GS</sub> =-30V, V <sub>DS</sub> =0V			-100	nA
VGS(TH)	Gate threshold voltage	V <sub>DS</sub> =V <sub>GS</sub> , I <sub>D</sub> =250uA	2.5	3.3	4.5	V
RDS(ON)	Drain to source on state resistance	V <sub>GS</sub> =10V, I <sub>D</sub> =3.2A		560	650	mΩ
Ciss	Input capacitance			438		
Coss	Output capacitance	V <sub>GS</sub> =0V, V <sub>DS</sub> =100V, f=1MHz		19.5		pF
Crss	Reverse transfer capacitance			1.32		
td(on)	Turn on delay time			84.8		
tr	Rising time	V <sub>DS</sub> =400V, I <sub>D</sub> =3.2A,		25.2		
td(off)	Turn off delay time	$R_G$ =4.7 $\Omega$ , $V_{GS}$ =10V		227.6		ns
t <sub>f</sub>	Fall time			26.8		
Qg	Total gate charge			11		
Qgs	Gate-source charge	V <sub>DS</sub> =480V, V <sub>GS</sub> =10V, I <sub>D</sub> =3.2A		2.1		nC
$Q_{gd}$	Gate-drain charge			5.6		nc
IS	Continuous source current	Integral reverse p-n Junction			11	А
ISM	Pulsed source current	diode in the MOSFET			44	А
VSD	Diode forward voltage drop.	Is=3.2A, V <sub>GS</sub> =0V	-	0.7	1.5	V
Trr	Reverse recovery time	Is=3.2A, V <sub>GS</sub> =0V, Vdd=400V,		313		ns
Qrr	Reverse recovery Charge	dI <sub>F</sub> /dt=100A/us,		0.877		uC

Note :

1. The data tested by surface mounted on a 1 inch2 FR-4 board with 2OZ copper.

2、The EAS data shows Max. rating . L=0.5mH, IAS =3.2A, VDD =50V, RG=25 $\Omega$ 

3、The test condition is Pulse Test: ISD ≤ ID, di/dt = 100A/us, VDD≤ BVDSS, Starting at TJ =25℃

 $4\,{\scriptstyle \smallsetminus}\,$  The power dissipation is limited by  $150\,{\rm ^{\circ}C}$  junction temperature

5. The data is theoretically the same as ID and IDM, in real applications, should be limited by total power dissipation.

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## 650V N-Channel Enhancement Mode MOSFET

#### **Typical Characteristics**

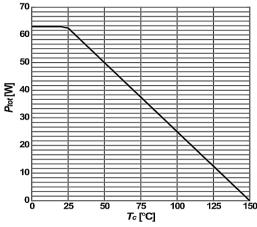


Figure1: Power dissipation (Non FullPAK)

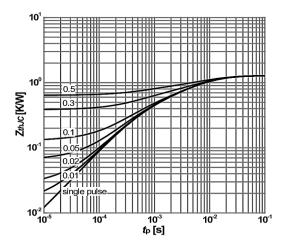
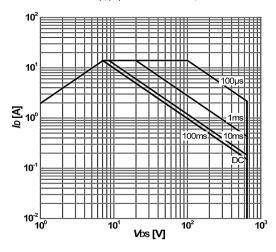


Figure3:Max. transient thermal impedance  $Z_{thJC}=f(t_p)$ ; parameter:  $D=t_p/T$ 



**Figure5: Safe operating area (Non FullPAK)** *I*<sub>D</sub>=f(*V*<sub>DS</sub>); *T*j=25°C; D=0; parameter: *t*<sub>p</sub>

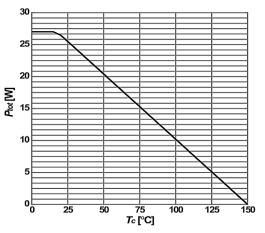


Figure2: Power dissipation (FullPAK)

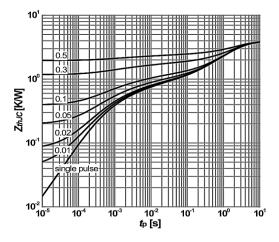


Figure4:Max. transient thermal impedance  $Z_{thJC}=f(t_p)$ ; parameter: D=  $t_p/T$ 

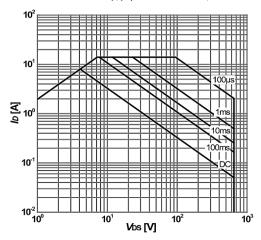
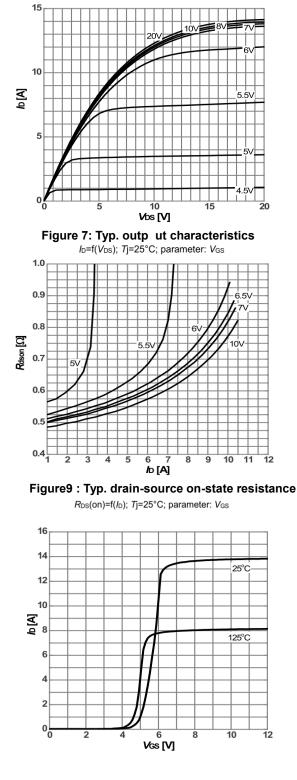


Figure6: Safe operating area (FullPAK) *I*<sub>D</sub>=f(V<sub>DS</sub>); *T*j=25°C; D=0; parameter: *t*<sub>P</sub>

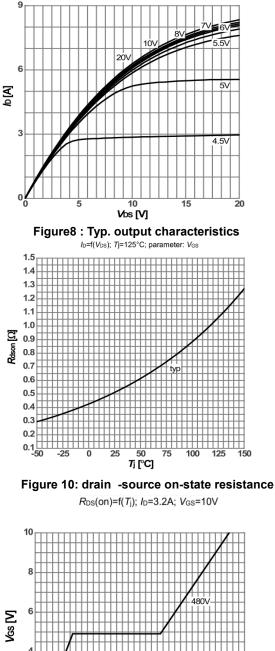


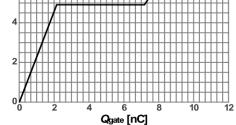
## <u>APJ14N65F/P/T (AP65R650)</u>

## 650V N-Channel Enhancement Mode MOSFET









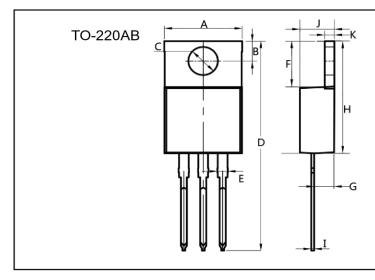


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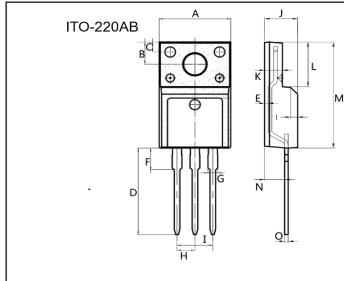


# APJ14N65F/P/T (AP65R650) 650V N-Channel Enhancement Mode MOSFET

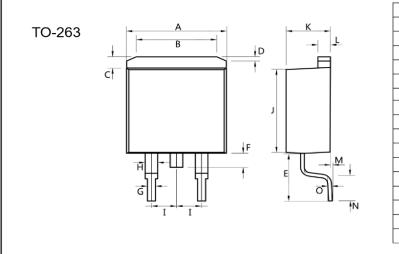
## Package Mechanical Data-TO-X



Dim.	Min.	Max.
А	10.0	10.4
В	2.5	3.0
С	3.5	4.0
D	28.0	30.0
E	1.1	1.5
F	6.2	6.6
G	2.9	3.3
Н	15.0	16.0
I	0.35	0.45
J	4.3	4.7
К	1.2	1.4
All Dimensions in millimeter		



Dim.	Min.	Max.	
А	9.9	10.3	
В	2.9	3.5	
С	1.15	1.45	
D	12.75	13.25	
E	0.55	0.75	
F	3.1	3.5	
G	1.25	1.45	
Н	Typ 2.54		
I	Typ 5.08		
J	4.55	4.75	
K	2.4	2.7	
L	6.35	6.75	
М	15.0	16.0	
Ν	2.75	3.15	
0	0.45	0.60	
All Dimensions in millimeter			



Dim.	Min.	Max.
A	10.0	10. 5
В	7.25	7.75
С	1.3	1.5
D	0.55	0.75
E	5.0	6.0
F	1.4	1.6
G	0.75	0.95
Н	1.15	1.35
I	Typ 2.54	
J	8.4	8.6
К	4.4	4.6
L	1.25	1.45
М	0.02	0.1
Ν	2.4	2.8
0	0.35	0.45
All Dimensions in millimeter		

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### 650V N-Channel Enhancement Mode MOSFET

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# APJ14N65F/P/T (AP65R650) 650V N-Channel Enhancement Mode MOSFET

Edition	Date	Change
Rve1.0	2018/1/31	Initial release

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